

ET1893

End Termination

Description

ET1893 is a low temperature plateable Ag End Termination. ET1893 has excellent adhesion to a variety of ceramic compositions when fired at $\leq 600^{\circ}\text{C}$. ET1893 is supplied with a rheology suitable for automatic dipping machines.

Key Features

- Nickel plateable Firing temperature less than 600°C
Machine dippable



This picture does not show the packaging of ET1893 and is solely intended for illustration purposes. The products are available in different packaging configurations and may change over time. Please refer to the latest safety data sheets for safety-relevant pictograms.

Typical Properties

Viscosity	15 – 30 Kcps Brookfield RVT SC4 – 14 spindle, 6R utility cup at 10 rpm, 25 °C
Solids	79.0 ± 1.0 %
Alloy Ratio	100
Metal	Ag

Recommended Processing Guide

Drying Temperature	150 °C for 10 minutes
Process Temperature (TDS)	525 – 600 °C peak temperature Dwell time of 1 – 2 minutes at peak
Recommended Thinner	RV-372

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Warranty

6 months

Storage

Store in a dry location at 5 – 25 °C.

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